- 8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion with Storage
- Asynchronous Parallel Clear
- Active High Decoder
- Enable/Disable Input Simplified Expansion
- Expandable for N-Bit Applications
- Four District Functional Modes
- Package Options Include Ceramic Chip Carriers and Flat Packages in Addition to Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

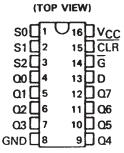
description

These 8-bit addressable latches are designed for general purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

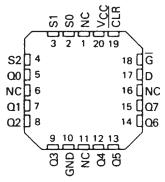
Four distinct modes of operation are selectable by controlling the clear (CLR) and enable (G) inputs as enumerated in the function table. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch will follow the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possiblity of entering erroneous data in the latches, enable G should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output will follow the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

The SN54259 and SN54LS259B are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74259 and SN74LS259B are characterized for operation from 0°C to 70°C.

SN54259, SN54LS259B . . . J OR W PACKAGE SN74259 . . . N PACKAGE SN74LS259B . . . D OR N PACKAGE

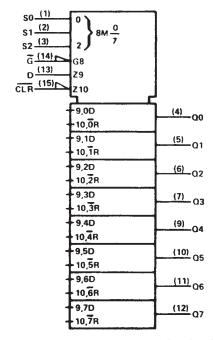


SN54LS259B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



FUNCTION TABLE

INPUT		OUTPUT OF ADDRESSED	EACH OTHER	FUNCTION
CLR	G	LATCH	OUTPUT	
Н	L	D	Q _{iO}	Addressable Latch
н	Н	Q _{iO}	Q _{iO}	Memory
L	L	D	L	8-Line Demultiplexer
L	Н	L	L	Clear

 $H \equiv high \ level, \ L \equiv low \ level$

LATCH SELECTION TABLE

SEL	ECT IN	IPUTS	LATCH
S2	S1	SO	ADDRESSED
L	L	L	0
L	L	H	1
L	Н	L	2
L	Н	H	3
н	L	L	4
Н	L	Н	5
Н	Н	L	6
Н	Н	н	7

schematic of inputs and outputs 259

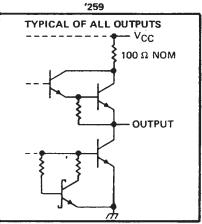
EQUIVALENT OF EACH INPUT

VCC

Req

INPUT \overline{G} : Req = 2.2 k Ω NOM

All other inputs: Req = 4 k Ω NOM



TEQUIVALENT OF \overline{G} INPUT

EQUIVALENT OF ALL OTHER INPUTS

VCC

Req = 10 k Ω NOM

INPUT

INPUT

OUTPUT

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage (see Note 1)		 7 V
Input voltage: SN54259, SN74259		 5.5 V
Operating free-air temperature range:	SN54259, SN54LS259B	 - 55°C to 125°C
	SN74259, SN74LS259B	 0°C to 70°C
Storage temperature range		 - 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



D ≡ the level at the data input

 $[\]alpha_{i0} \equiv$ the level of α_i (i = 0, 1, . . . 7, as appropriate) before the indicated steady-state input conditions were established.

recommended operating conditions

		SN54	259	SN742	259	
		MIN NO	MIN NO	UNIT		
Supply voltage, V _{CC}		4.5	5 5.5	4.75	5 5.25	V
High-level output current, IOH			-800		800	μΑ
Low-level output current, IOL			16		16	mA
Width of clear or enable pulse, tw		15		15		ns
	Data	15↑		151		
Setup time, t _{gU}	Address	5↑		5↑		ns
11.11.1	Data	0↑		01		
Hold time, th	Address	20↑		20†		ns
Operating free-air temperature, TA		-55	125	0	70	°C

[†]The arrow indicates that the rising edge of the enable pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED		TEST OF	NDITIONS†	S	N5425	9		N7425	9	UNIT
	PARAMETER		I EST CC	י פאטוווטאק.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
ViH	High-level input voltag	e			2			2			V
VIL	Low-level input voltage	•					0.8			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I = 12 mA			-1.5			-1.5	V
Voн	High-level output volta	ge	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -800 μA	2.4	3.4		2.4	3.4		V
VOL	Low-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
I _I	Input current at maxin	num input voltage	V _{CC} = MAX,	V ₁ = 5.5 V			1			1	mA
	High-level input	Ğ	1/ - 11A V	V = 2.4 V	ĺ		80			80	
ΙΗ	current	Other inputs	V _{CC} = MAX,	V ₁ = 2.4 V			40			40	μА
	Low-level input	G	V - 444 V	V - 0 4 V	Ī		-3.2			-3.2	
HL	current	Other inputs	V _{CC} = MAX,	V _I = 0.4 V			-1.6			-1.6	mA
los	Short-circuit output cu	ırrent§	V _{CC} = MAX		-18		-57	-18		– 57	mA
Icc	Supply current		V _{CC} = MAX,	See Note 2		60	90	1	60	90	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PHL	CLR	Any Q			16	25	ns
tPLH	0		1		14	24	-
^t PHL	Data	Any Q	CL = 15 pF,		11	20	ns
^t PLH			R _L = 400 Ω,		15	28	ns
tPHL	Address	Any Q	See Note 3		17	28	7 "
[†] PLH	_		1		12	20	1
tPHL	Ğ	Any Q			11	20	ns

t_{PLH} = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time.

NOTE 2: $I_{\mbox{\footnotesize{CC}}}$ is measured with the inputs grounded and the outputs open.

tpHL = propagation delay time, high-to-low-level output

recommended operating conditions

			SI	154LS2	59B	SN	174LS25	59B	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage		2	•		2			V
VIL	Low-level input voltage				0.7			0.8	V
ЮН	High-level output current				- 0.4			- 0.4	mA
IOL	Low-level output current				4			8	mA
	Pulse duration	G low	17			17			
tw	ruise duration	CLR low	10			10			, ris
		Data before G †	20			20			
t _{su}	Set up time	Address before G†	17			17			пѕ
		Address before G1	0			0			
		Data after G t	0			0			
th	Hold time	Address after G †	0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		Sf	N54LS2	5 9B	SN	UNIT					
FANAMETER		TEST CONI	Dilions.		MIN	TYP	MAX	MIN	TYP	MAX	ONT
VIK	V _{CC} = MIN,	I _I = - 18 mA					1.5			- 1.5	V
Vон	V _{CC} = MIN, I _{OH} = - 0.4 m	V _{IH} = 2 V, A	VIL = MAX,		2.5	3.4		2.7	3.4		V
V	V _{CC} = MIN,	V _{IH} = 2 V,		IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	VIL = MAX			IOL = 8 mA					0.35	0.5	1 °
l ₁	V _{CC} = MAX,	V _I = 7 V					0.1			0.1	mA
Чн	V _{CC} = MAX,	V ₁ = 2.7 V					20			20	μА
IIL	V _{CC} = MAX,	V _I = 0.4 V				-	- 0.4			- 0.4	mA
los§	V _{CC} = MAX				- 20		- 100	- 20		- 100	mA
lcc	V _{CC} = MAX,	See Note 2			<u> </u>	27	36	· 	22	36	mA

 $^{^\}dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN T	YP MAX	UNIT
tPHL	CLR	Any Q			12 18	ns
^t PLH	Data	Any Q			19 30	
^t PHL	Data	Anya	C. = 15 nF		13 20	ns
^t PLH	Address	Any Q	C _L = 15 pF, R _L = 2 ks See Note 3	12,	17 27	
tPHL	Address	Any Q	See Note 3		14 20	ns
^t PLH	Ğ	Any Q			15 24	
^t PHL	3	Any Q			15 24	ns

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



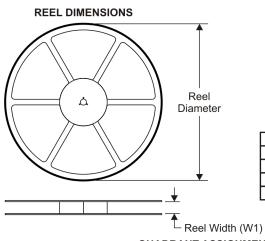
 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

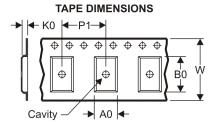
 $[\]S$ Not more than one output should be shorted at a time, and duration short-circuit should not exceed one second.

NOTE 2: $I_{\mbox{\footnotesize{CC}}}$ is measured with the inputs grounded and the outputs open.



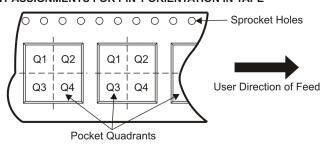
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

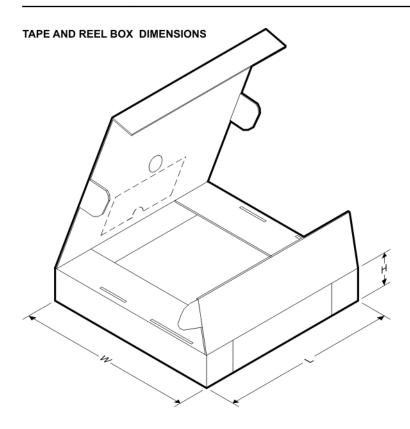
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS259BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS259BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS259BDR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS259BNSR	SO	NS	16	2000	346.0	346.0	33.0

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